

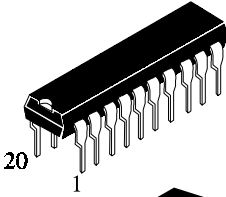
IN74AC643

Octal 3-State Bus Transceiver
High-Speed Silicon-Gate CMOS

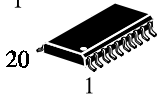
The IN74AC643 is identical in pinout to the LS/ALS643, HC/HCT643. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALS outputs.

The IN74AC643 is a 3-state transceiver that is used for 2-way asynchronous communication between data buses. The device has an active-low Output Enable pin, which is used to place the I/O ports into high-impedance states. The Direction control determines whether data flows from A to B or from B to A.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 μ A; 0.1 μ A @ 25°C
- High Noise Immunity Characteristic of CMOS Devices
- Outputs Source/Sink 24 mA



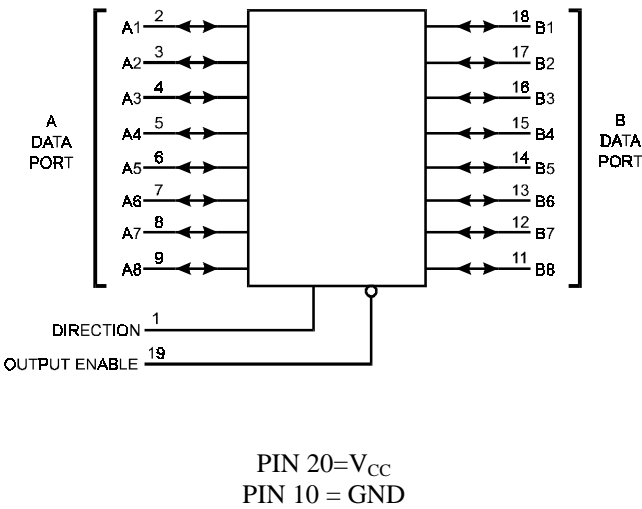
N SUFFIX
PLASTIC



DW SUFFIX
SOIC

ORDERING INFORMATION
IN74AC643N Plastic
IN74AC643DW SOIC
 $T_A = -40^{\circ}$ to 85° C for all packages

LOGIC DIAGRAM



PIN ASSIGNMENT

DIRECTION	1	20	V_{CC}
A1	2	19	OUTPUT ENABLE
A2	3	18	B1
A3	4	17	B2
A4	5	16	B3
A5	6	15	B4
A6	7	14	B5
A7	8	13	B6
A8	9	12	B7
GND	10	11	B8

FUNCTION TABLE

Control Inputs		Operation
Output Enable	Direction	
L	L	Data Transmitted from Bus B to Bus A
L	H	Data Transmitted from Bus A to Bus B (inverted)
H	X	Buses Isolated (High Impedance State)

X = don't care

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V_{IN}	DC Input Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to $V_{CC} + 0.5$	V
I_{IN}	DC Input Current, per Pin	± 20	mA
I_{OUT}	DC Output Sink/Source Current, per Pin	± 50	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	± 50	mA
P_D	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C
SOIC Package: : - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	2.0	6.0	V
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V
T _J	Junction Temperature (PDIP)		140	°C
T _A	Operating Temperature, All Package Types	-40	+85	°C
I _{OH}	Output Current - High		-24	mA
I _{OL}	Output Current - Low		24	mA
t _r , t _f	Input Rise and Fall Time *			
	V _{CC} =3.0 V	0	150	ns/V
	V _{CC} =4.5 V	0	40	
V _{CC} =5.5 V	0	25		

* V_{IN} from 30% to 70% V_{CC}

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}).
Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS(Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V _{CC} V	Guaranteed Limits		Unit
				25 °C	-40°C to 85°C	
V _{IH}	Minimum High-Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	3.0 4.5 5.5	2.1 3.15 3.85	2.1 3.15 3.85	V
V _{IL}	Maximum Low - Level Input Voltage	V _{OUT} =0.1 V or V _{CC} -0.1 V	3.0 4.5 5.5	0.9 1.35 1.65	0.9 1.35 1.65	V
V _{OH}	Minimum High-Level Output Voltage	I _{OUT} ≤ -50 µA	3.0 4.5 5.5	2.9 4.4 5.4	2.9 4.4 5.4	V
		*V _{IN} =V _{IH} or V _{IL} I _{OH} =-12 mA	3.0	2.56	2.46	
		I _{OH} =-24 mA	4.5	3.86	3.76	
		I _{OH} =-24 mA	5.5	4.86	4.76	
V _{OL}	Maximum Low-Level Output Voltage	I _{OUT} ≤ 50 µA	3.0 4.5 5.5	0.1 0.1 0.1	0.1 0.1 0.1	V
		*V _{IN} =V _{IH} or V _{IL} I _{OL} =12 mA	3.0	0.36	0.44	
		I _{OL} =24 mA	4.5	0.36	0.44	
		I _{OL} =24 mA	5.5	0.36	0.44	
I _{IN}	Maximum Input Leakage Current	V _{IN} =V _{CC} or GND	5.5	±0.1	±1.0	µA
I _{OZ}	Maximum Three-State Leakage Current	V _{IN} (OE)= V _{IH} or V _{IL} V _{IN} =V _{CC} or GND V _{OUT} =V _{CC} or GND	5.5	±0.6	±6.0	µA
I _{OLD}	+Minimum Dynamic Output Current	V _{OLD} =1.65 V Max	5.5		75	mA
I _{OHD}	+Minimum Dynamic Output Current	V _{OHD} =3.85 V Min	5.5		-75	mA
I _{CC}	Maximum Quiescent Supply Current (per Package)	V _{IN} =V _{CC} or GND	5.5	8.0	80	µA

* All outputs loaded; thresholds on input associated with output under test.

+Maximum test duration 2.0 ms, one output loaded at a time.

Note: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}

AC ELECTRICAL CHARACTERISTICS($C_L=50\text{pF}$, Input $t_r=t_f=3.0\text{ ns}$)

Symbol	Parameter	V _{CC} [*] V	Guaranteed Limits				Unit
			25 °C		-40°C to 85°C		
			Min	Max	Min	Max	
t _{PLH}	Propagation Delay, A to B or B to A (Figure 1)	3.3 5.0	1.5 1.5	8.5 6.5	1.0 1.0	9.5 7.5	ns
t _{PHL}	Propagation Delay, A to B or B to A (Figure 1)	3.3 5.0	1.5 1.5	8.5 6.5	1.0 1.0	9.5 7.5	ns
t _{PZH}	Propagation Delay, Direction or Output Enable to A or B (Figure 2)	3.3 5.0	2.5 1.5	12.5 9.5	2.0 1.0	13.5 10.0	ns
t _{PZL}	Propagation Delay, Direction or Output Enable to A or B (Figure 2)	3.3 5.0	2.5 1.5	12.5 9.5	2.0 1.0	13.5 10.0	ns
t _{PHZ}	Propagation Delay, Direction or Output Enable to A or B (Figure 2)	3.3 5.0	2.0 1.5	12.0 9.0	1.0 1.0	12.5 10.0	ns
t _{PLZ}	Propagation Delay, Direction or Output Enable to A or B (Figure 2)	3.3 5.0	2.0 1.5	12.0 9.5	1.5 1.0	13.5 10.5	ns
C _{IN}	Maximum Input Capacitance	5.0	4.5		4.5		pF
C _{OUT}	Maximum Tree-State I/O Capacitance (Output in High-Impedance State0	5.0	15		15		pF

C _{PD}	Power Dissipation Capacitance	Typical @25°C,V _{CC} =5.0 V	pF
		45	

*Voltage Range 3.3 V is 3.3 V \pm 0.3 V

Voltage Range 5.0 V is 5.0 V \pm 0.5 V

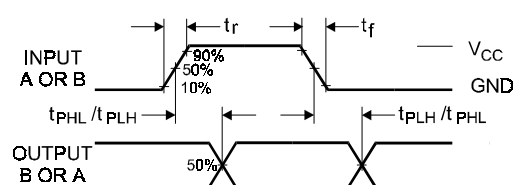


Figure 1. Switching Waveforms

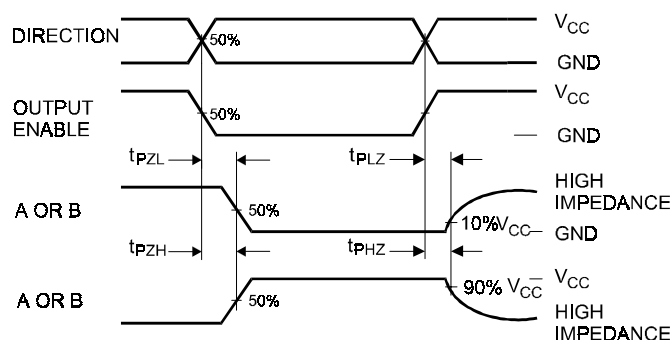


Figure 2. Switching Waveforms

EXPANDED LOGIC DIAGRAM

